

CTLTVS6V2

SURFACE MOUNT SILICON TRANSIENT VOLTAGE SUPPRESSOR



www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CTLTVS6V2 is a low leakage, fast response silicon TVS packaged in an ultra small, ultra low profile TLM2D3D6 surface mount case. This device is designed to protect sensitive equipment against ESD damage.



APPLICATIONS:

- User interface protection
- Voltage rail protection
- Data line protection
- Voltage clamping

MARKING CODE: S

FEATURES:

- Ultra small, ultra low profile 0.3mm x 0.6mm x 0.3mm TLP™ leadless surface mount package
- High peak pulse current capability
- Low leakage current
- 15kV ESD protection

MAXIMUM RATINGS: ($T_A=25^\circ C$)

Peak Power Dissipation (8x20 μs)

ESD Voltage (IEC 61000-4-2, Air)

Operating and Storage Junction Temperature

	SYMBOL	UNITS
	P_{PK}	W
	V_{ESD}	kV
	T_J, T_{stg}	°C

ELECTRICAL CHARACTERISTICS: ($T_A=25^\circ C$) $V_F=1.0V$ MAX @ $I_F=10mA$

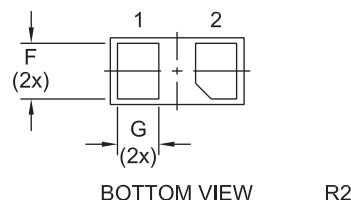
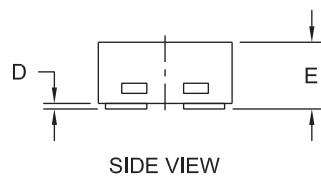
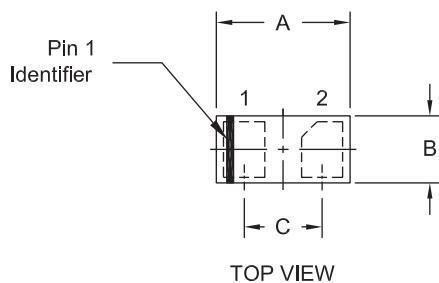
Maximum Reverse Stand-off Voltage V_{RWM}	Breakdown Voltage			Test Current I_T	Maximum Reverse Leakage Current $I_R @ V_{RWM}$	Maximum Clamping Voltage $V_C @ I_{PP}$	Peak Pulse Current I_{PP}	Typical Junction Capacitance @ 0V Bias C_J
	MIN V	NOM V	MAX V					
4.0	5.8	6.2	6.6	5.0	1.0	10.7	3.0	25

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TLM2D3D6 CASE - MECHANICAL OUTLINE



SYMBOL	DIMENSIONS			
	INCHES	MILLIMETERS	MIN	MAX
A	0.022	0.026	0.55	0.65
B	0.010	0.014	0.25	0.35
C		0.014		0.35
D	0.000	0.002	0.00	0.05
E	0.011	0.013	0.28	0.32
F	0.008	0.012	0.20	0.30
G	0.005	0.009	0.13	0.24

TLM2D3D6 (REV: R2)

LEAD CODE:

- 1) Cathode
- 2) Anode

MARKING CODE: S

R1 (23-January 2013)

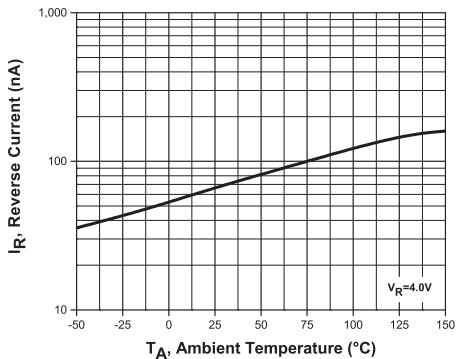
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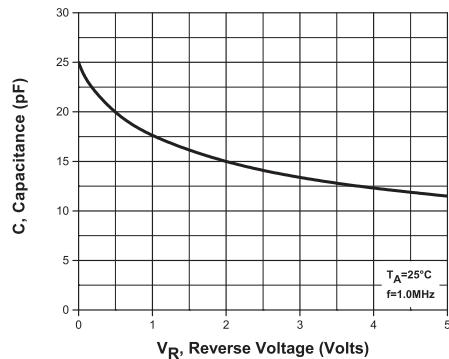


TYPICAL ELECTRICAL CHARACTERISTICS

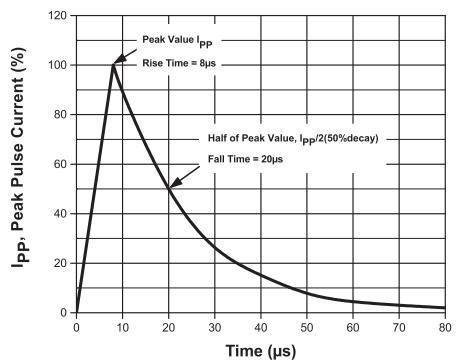
Leakage Current



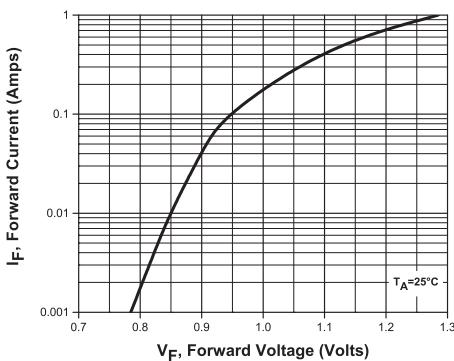
Capacitance



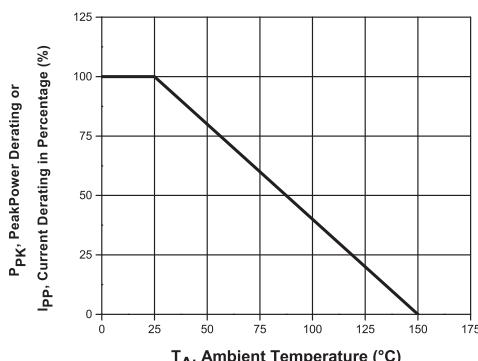
8 x 20 μ s Pulse Waveform



Forward Voltage



Power & Current Derating



R1 (23-January 2013)